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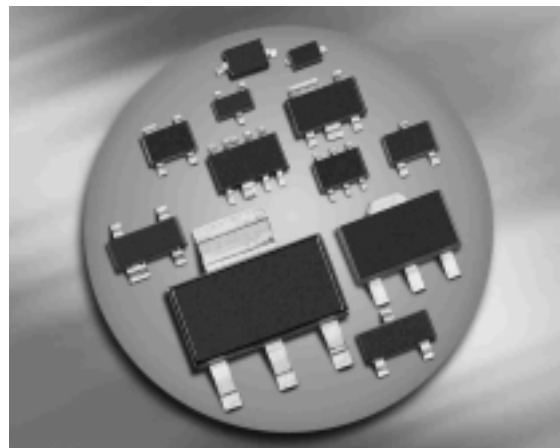
[sales@integrated-circuit.com](mailto:sales@integrated-circuit.com)



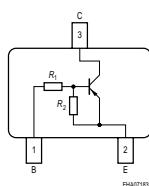
**BCR196...**

**PNP Silicon Digital Transistor**

- Switching circuit, inverter, interface circuit, driver circuit
- Built in bias resistor ( $R_1 = 47k\Omega$  ,  $R_2 = 22k\Omega$  )



**BCR196/F/L3**  
**BCR196T/W**



Type	Marking	Pin Configuration						Package
		1=B	2=E	3=C	-	-	-	
BCR196	WXs	1=B	2=E	3=C	-	-	-	SOT23
BCR196F	WXs	1=B	2=E	3=C	-	-	-	TSFP-3
BCR196L3	WX	1=B	2=E	3=C	-	-	-	TSLP-3-4
BCR196T	WX	1=B	2=E	3=C	-	-	-	SC75
BCR196W	WXs	1=B	2=E	3=C	-	-	-	SOT323


**BCR196...**
**Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CEO}$	50	V
Collector-base voltage	$V_{CBO}$	50	
Input forward voltage	$V_{i(fwd)}$	80	
Input reverse voltage	$V_{i(rev)}$	10	
Collector current	$I_C$	70	mA
Total power dissipation- BCR196, $T_S \leq 102^\circ\text{C}$ BCR196F, $T_S \leq 128^\circ\text{C}$ BCR196L3, $T_S \leq 135^\circ\text{C}$ BCR196T, $T_S \leq 109^\circ\text{C}$ BCR196W, $T_S \leq 124^\circ\text{C}$	$P_{tot}$	200 250 250 250 250	mW
Junction temperature	$T_j$	150	°C
Storage temperature	$T_{stg}$	150 ... -65	

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$		K/W
BCR196		$\leq 240$	
BCR196F		$\leq 90$	
BCR196L3		$\leq 60$	
BCR196T		$\leq 165$	
BCR196W		$\leq 105$	

<sup>1</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance


**BCR196...**
**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Collector-emitter breakdown voltage $I_C = 100 \mu\text{A}, I_B = 0$	$V_{(BR)CEO}$	50	-	-	V
Collector-base breakdown voltage $I_C = 10 \mu\text{A}, I_E = 0$	$V_{(BR)CBO}$	50	-	-	
Collector-base cutoff current $V_{CB} = 40 \text{ V}, I_E = 0$	$I_{CBO}$	-	-	100	nA
Emitter-base cutoff current $V_{EB} = 10 \text{ V}, I_C = 0$	$I_{EBO}$	-	-	220	$\mu\text{A}$
DC current gain <sup>1)</sup> $I_C = 5 \text{ mA}, V_{CE} = 5 \text{ V}$	$h_{FE}$	50	-	-	-
Collector-emitter saturation voltage <sup>1)</sup> $I_C = 10 \text{ mA}, I_B = 0,5 \text{ mA}$	$V_{CEsat}$	-	-	0,3	V
Input off voltage $I_C = 100 \mu\text{A}, V_{CE} = 5 \text{ V}$	$V_{i(off)}$	1,2	-	2,6	
Input on voltage $I_C = 2 \text{ mA}, V_{CE} = 0,3 \text{ V}$	$V_{i(on)}$	1,5	-	4	
Input resistor	$R_1$	32	47	62	$\text{k}\Omega$
Resistor ratio	$R_1/R_2$	1,92	2,14	2,36	-

**AC Characteristics**

Transition frequency $I_C = 10 \text{ mA}, V_{CE} = 5 \text{ V}, f = 100 \text{ MHz}$	$f_T$	-	150	-	MHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	$C_{cb}$	-	3	-	pF

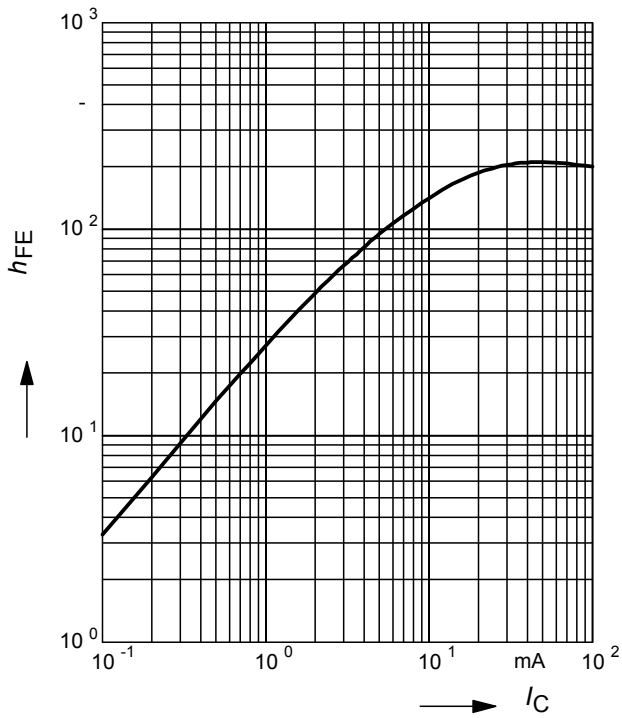
<sup>1</sup>Pulse test:  $t < 300 \mu\text{s}; D < 2\%$



**BCR196...**

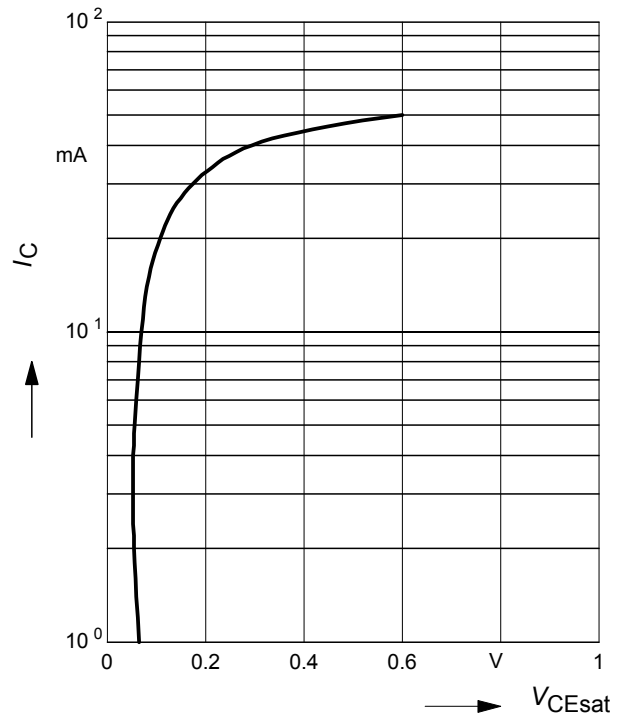
**DC current gain  $h_{FE} = f(I_C)$**

$V_{CE} = 5\text{ V}$  (common emitter configuration)



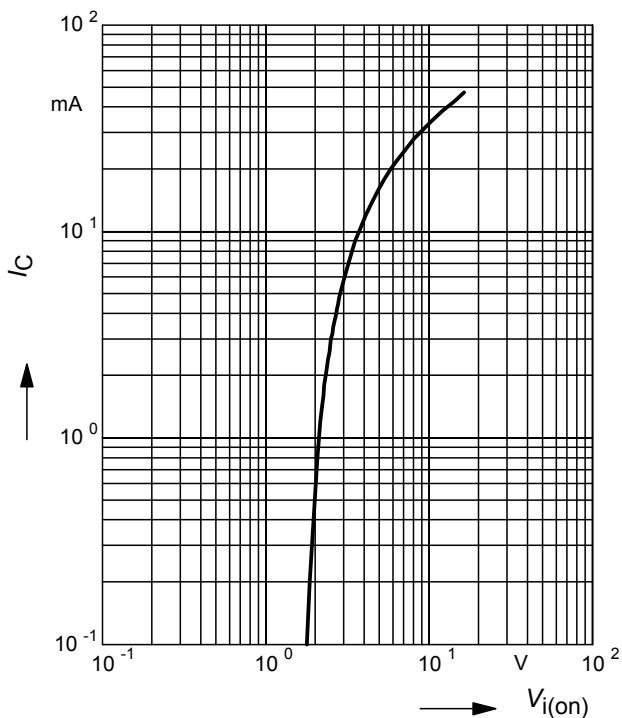
**Collector-emitter saturation voltage**

$V_{CEsat} = f(I_C), h_{FE} = 20$



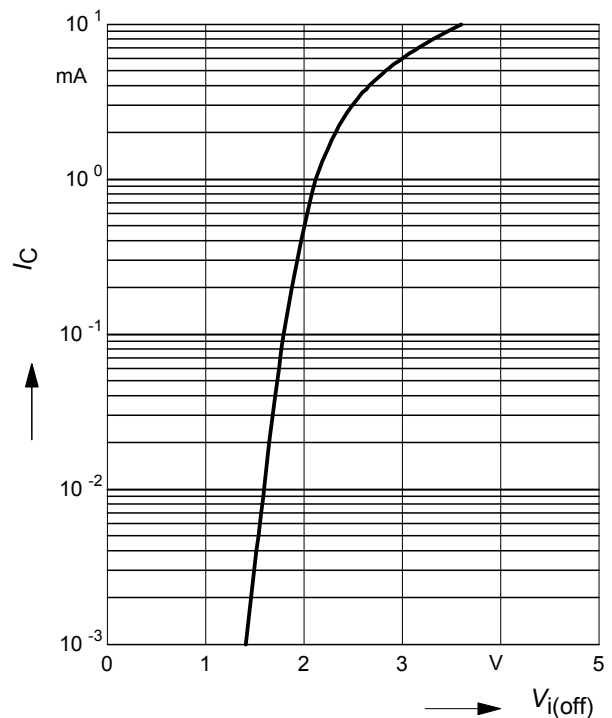
**Input on Voltage  $V_{i(on)} = f(I_C)$**

$V_{CE} = 0.3\text{ V}$  (common emitter configuration)



**Input off voltage  $V_{i(off)} = f(I_C)$**

$V_{CE} = 5\text{ V}$  (common emitter configuration)

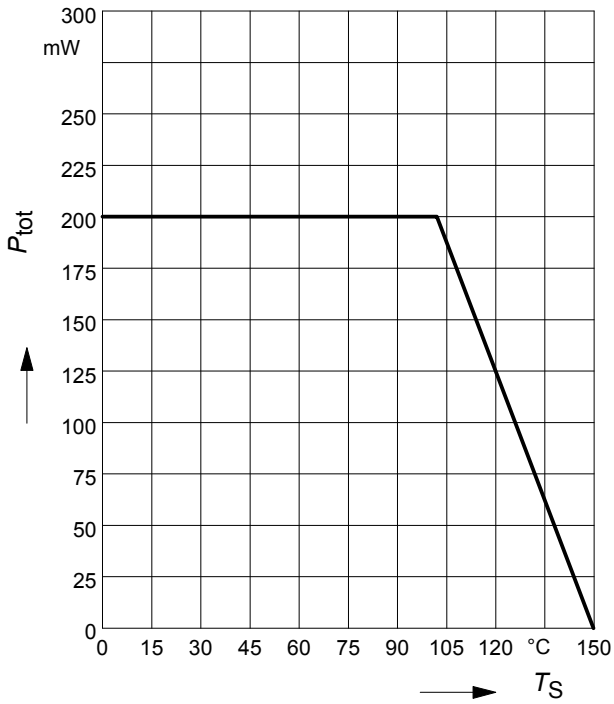




**BCR196...**

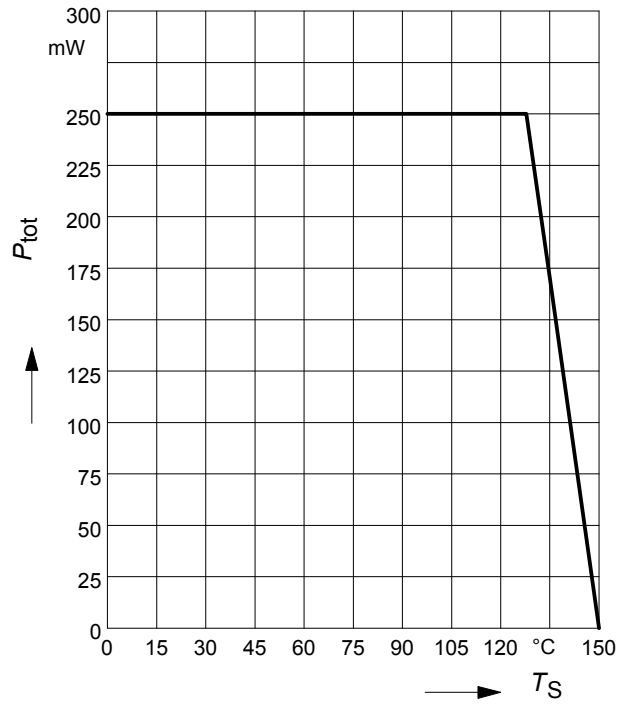
**Total power dissipation  $P_{tot} = f(T_S)$**

**BCR196**



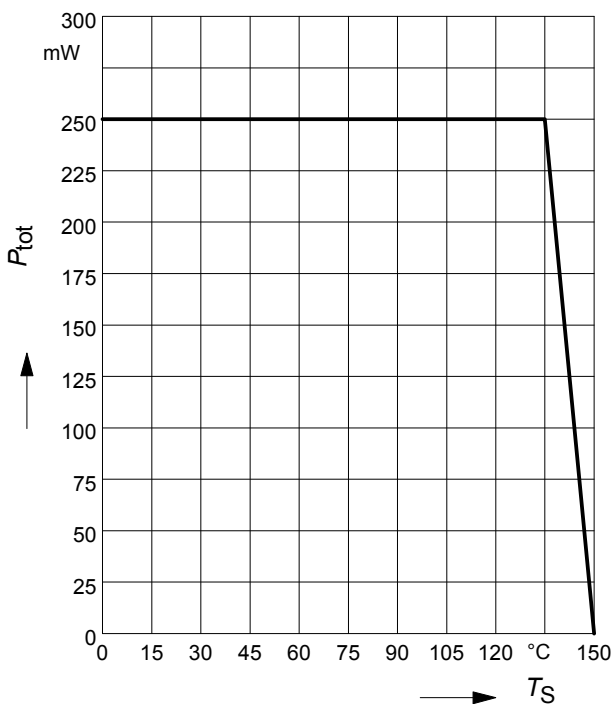
**Total power dissipation  $P_{tot} = f(T_S)$**

**BCR196F**



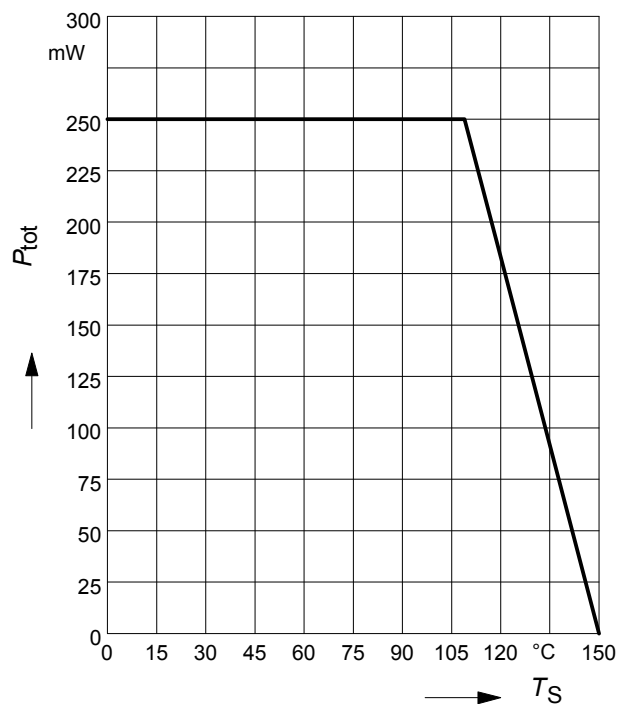
**Total power dissipation  $P_{tot} = f(T_S)$**

**BCR196L3**



**Total power dissipation  $P_{tot} = f(T_S)$**

**BCR196T**

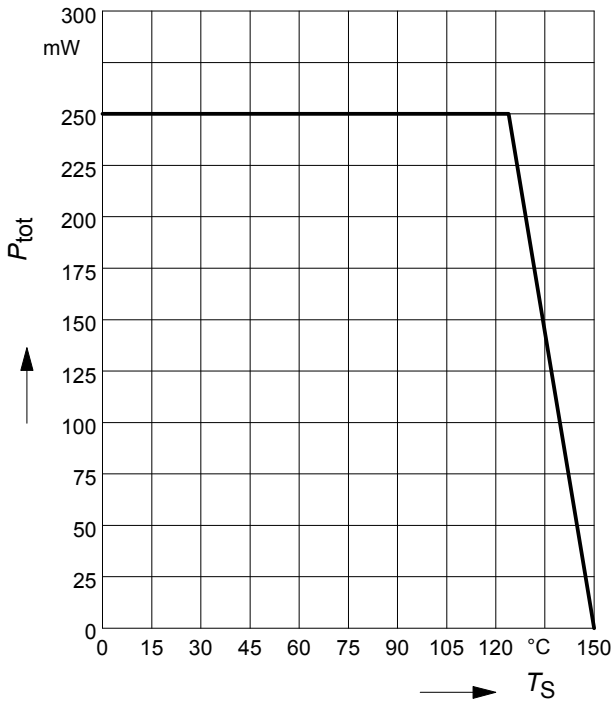




**BCR196...**

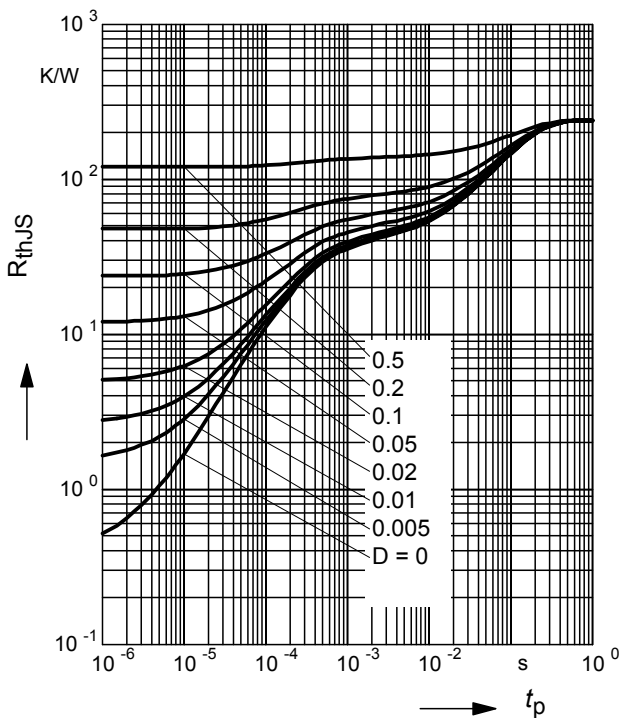
**Total power dissipation  $P_{tot} = f(T_S)$**

BCR196W



**Permissible Pulse Load  $R_{thJS} = f(t_p)$**

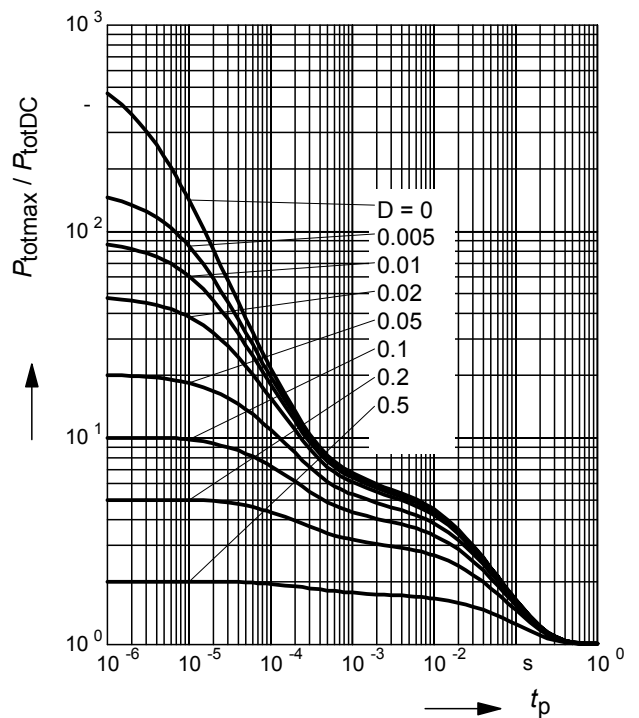
BCR196



**Permissible Pulse Load**

$P_{totmax}/P_{totDC} = f(t_p)$

BCR196

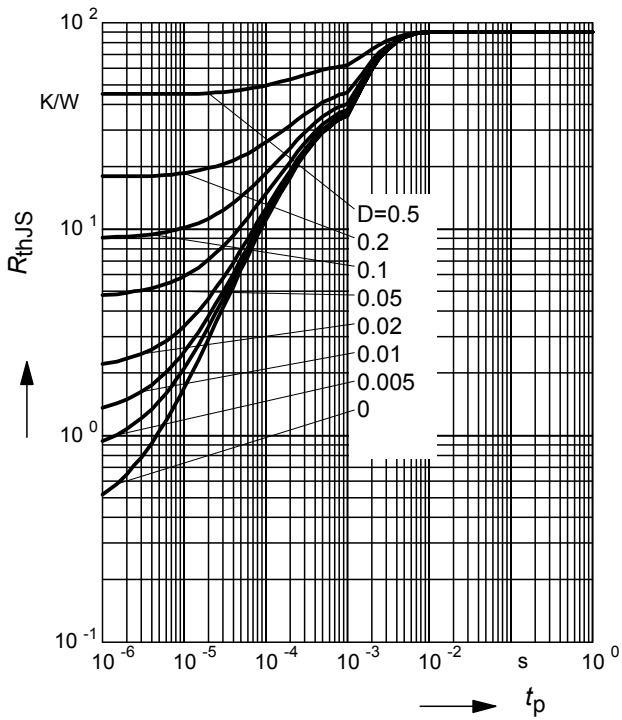




**BCR196...**

**Permissible Puls Load  $R_{thJS} = f(t_p)$**

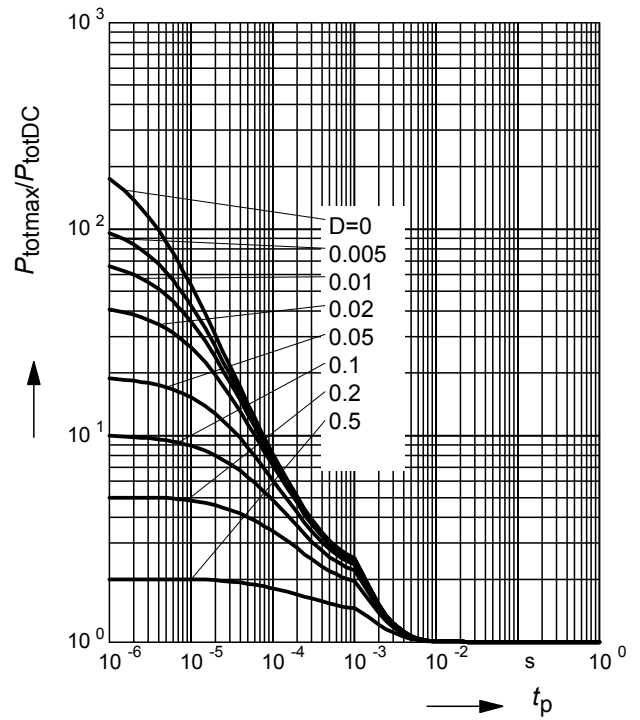
BCR196F



**Permissible Pulse Load**

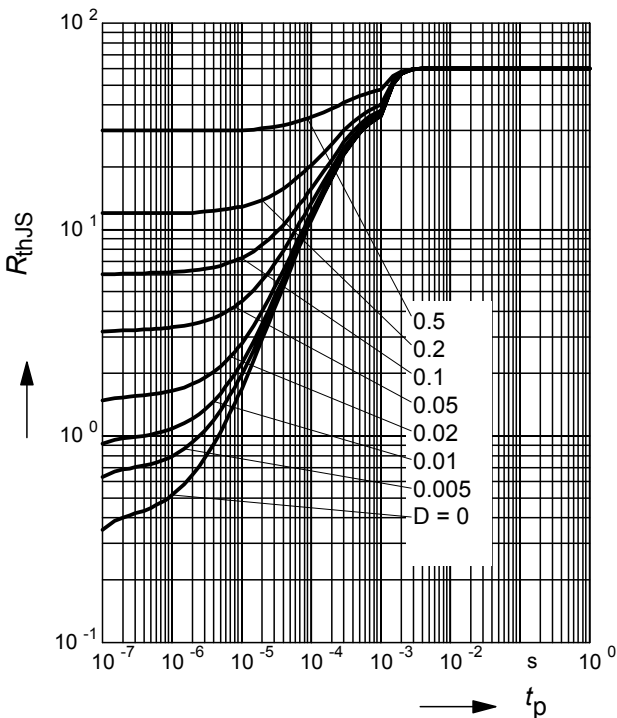
$P_{totmax}/P_{totDC} = f(t_p)$

BCR196F



**Permissible Puls Load  $R_{thJS} = f(t_p)$**

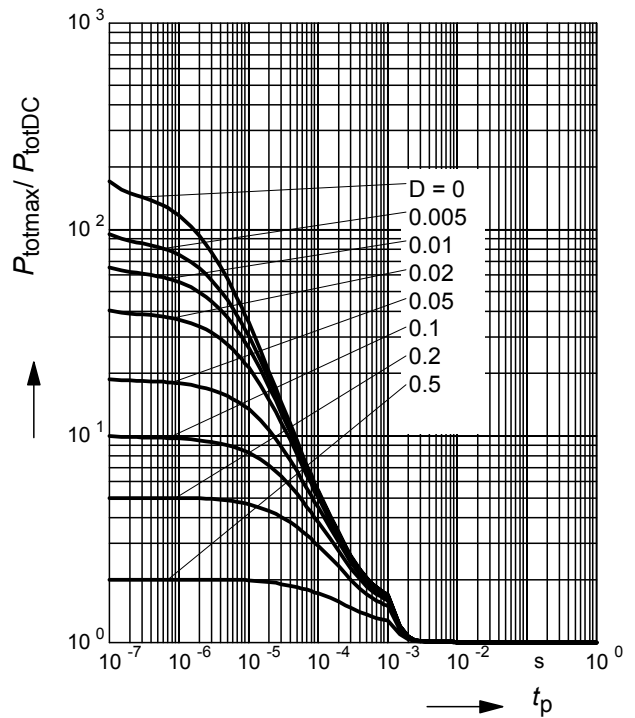
BCR196L3



**Permissible Pulse Load**

$P_{totmax}/P_{totDC} = f(t_p)$

BCR196L3



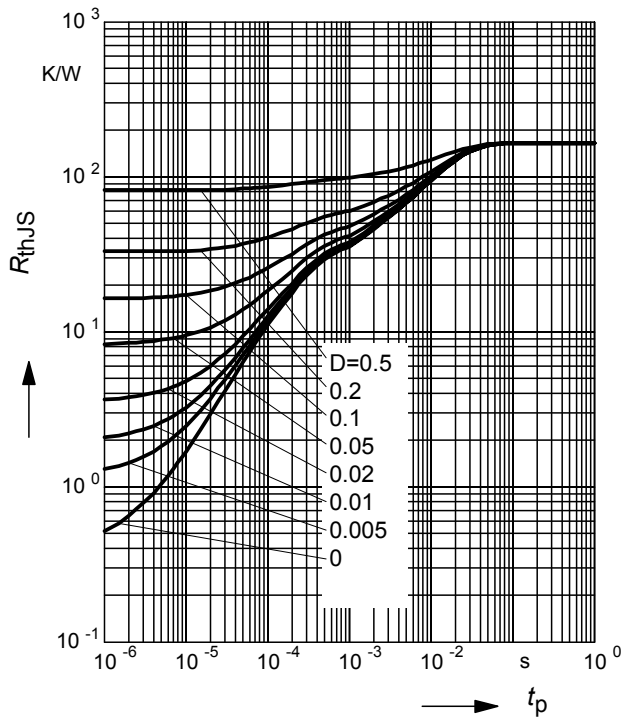




**BCR196...**

**Permissible Puls Load  $R_{thJS} = f(t_p)$**

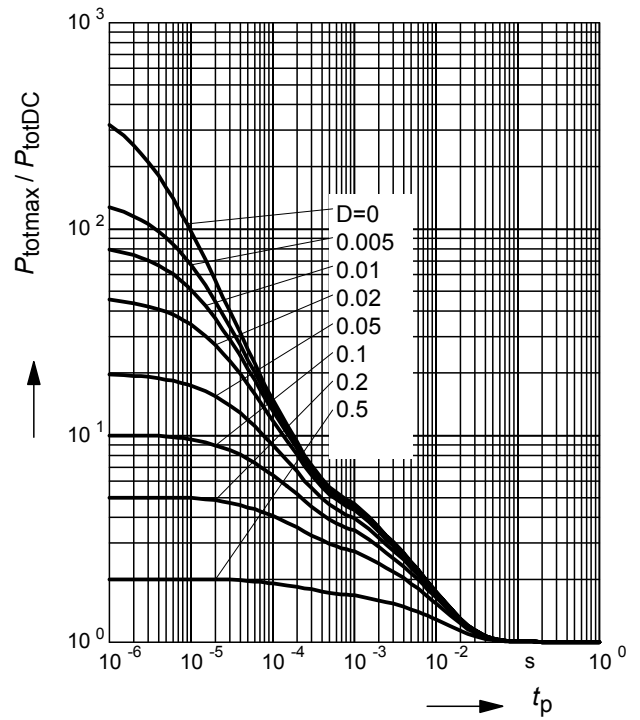
BCR196T



**Permissible Pulse Load**

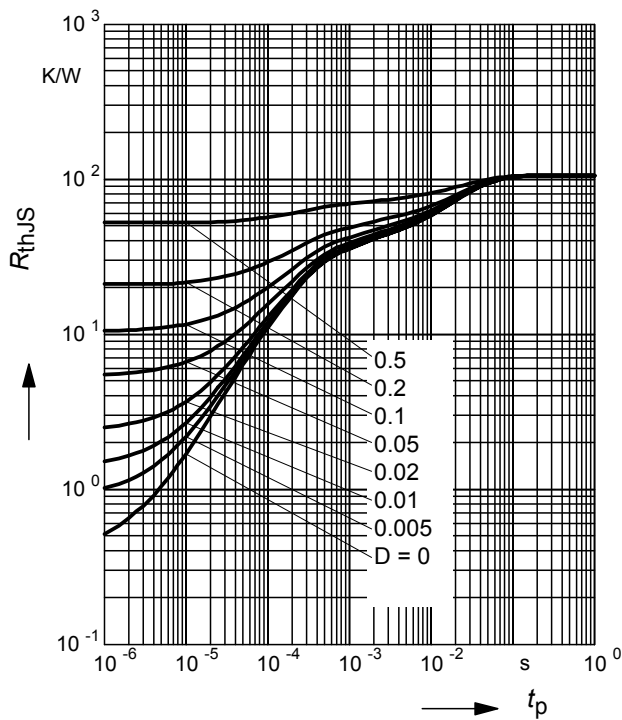
$P_{totmax}/P_{totDC} = f(t_p)$

BCR196T



**Permissible Puls Load  $R_{thJS} = f(t_p)$**

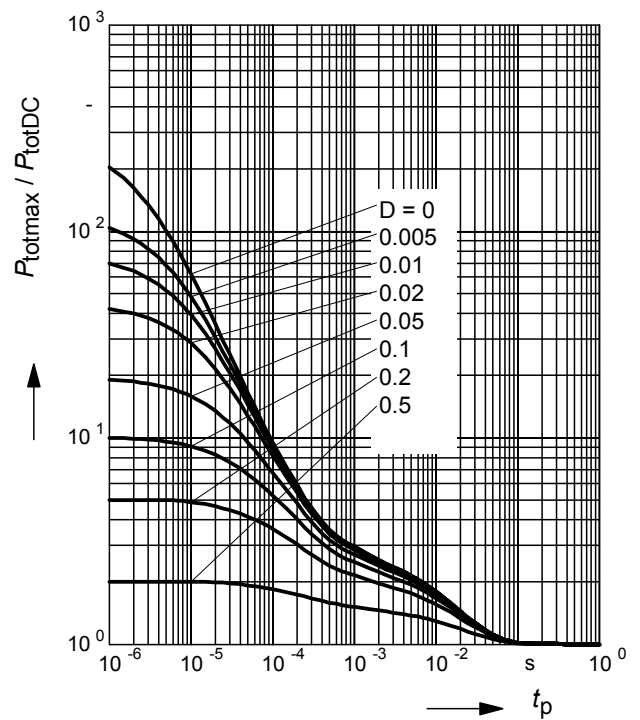
BCR196W



**Permissible Pulse Load**

$P_{totmax}/P_{totDC} = f(t_p)$

BCR196W

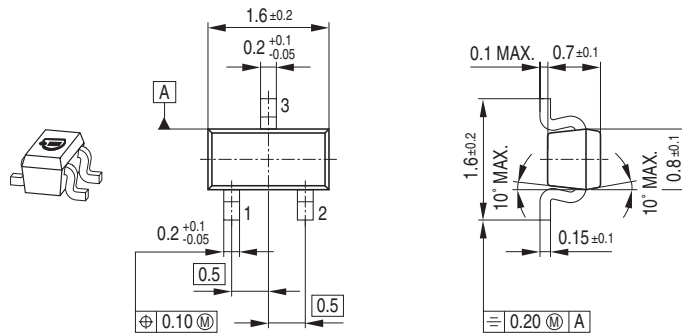




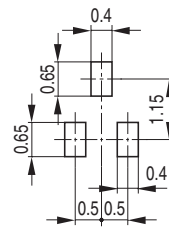
**Package SC75**

**BCR196...**

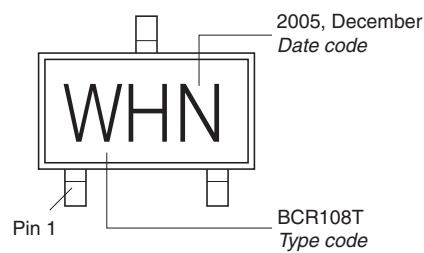
**Package Outline**



**Foot Print**

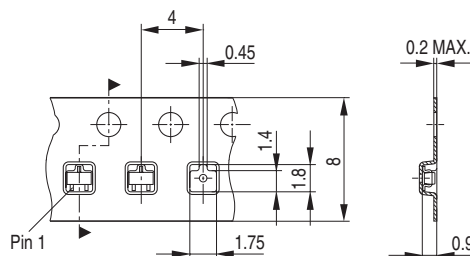


**Marking Layout (Example)**



**Standard Packing**

Reel ø180 mm = 3.000 Pieces/Reel  
 Reel ø330 mm = 10.000 Pieces/Reel





**BCR196...**

Date Code marking for discrete packages with one digit (SCD80, SC79, SC75<sup>1)</sup>) CES-Code

Month	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014
01	a	p	A	P	a	p	A	P	a	p	A	P
02	b	q	B	Q	b	q	B	Q	b	q	B	Q
03	c	r	C	R	c	r	C	R	c	r	C	R
04	d	s	D	S	d	s	D	S	d	s	D	S
05	e	t	E	T	e	t	E	T	e	t	E	T
06	f	u	F	U	f	u	F	U	f	u	F	U
07	g	v	G	V	g	v	G	V	g	v	G	V
08	h	x	H	X	h	x	H	X	h	x	H	X
09	j	y	J	Y	j	y	J	Y	j	y	J	Y
10	k	z	K	Z	k	z	K	Z	k	z	K	Z
11	l	2	L	4	l	2	L	4	l	2	L	4
12	n	3	N	5	n	3	N	5	n	3	N	5

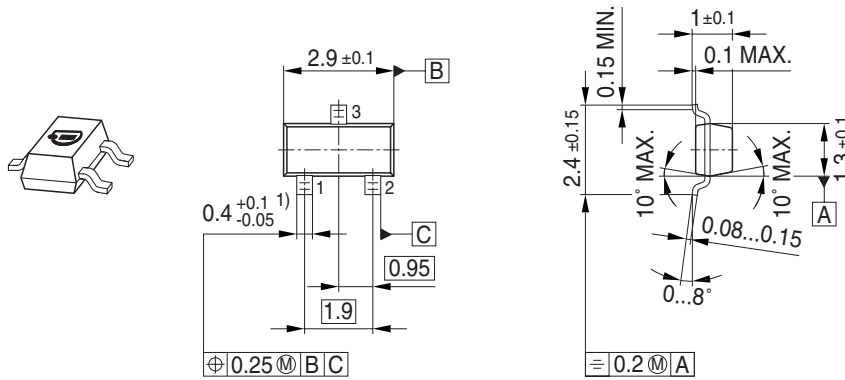
1) New Marking Layout for SC75, implemented at October 2005.



**Package SOT23**

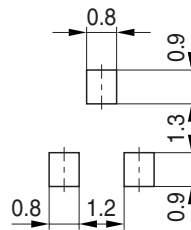
**BCR196...**

**Package Outline**

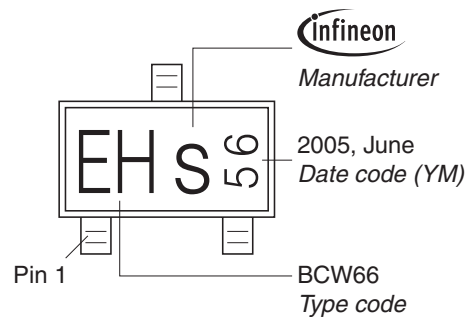


1) Lead width can be 0.6 max. in dambar area

**Foot Print**

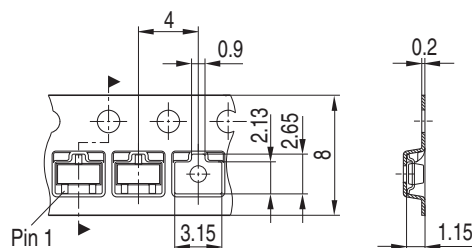


**Marking Layout (Example)**



**Standard Packing**

Reel ø180 mm = 3.000 Pieces/Reel  
 Reel ø330 mm = 10.000 Pieces/Reel

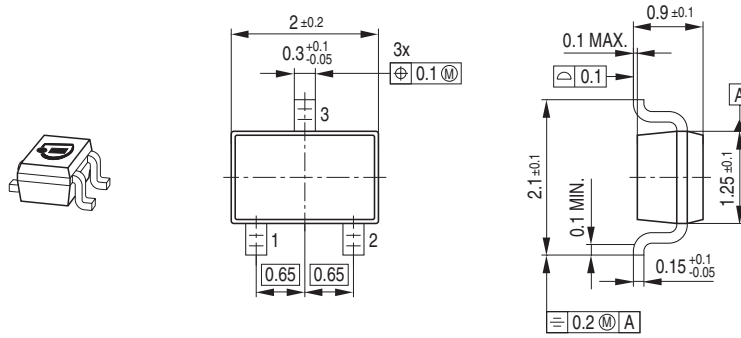




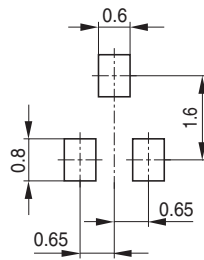
**Package SOT323**

**BCR196...**

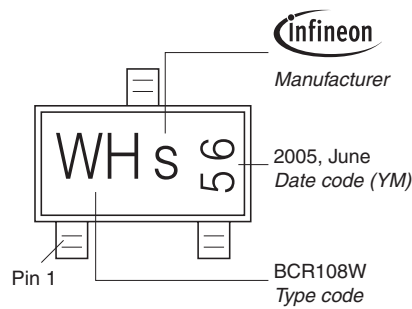
**Package Outline**



**Foot Print**

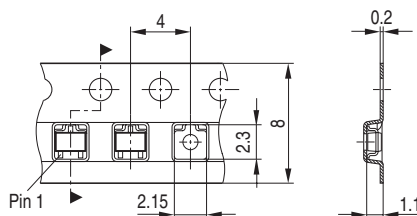


**Marking Layout (Example)**



**Standard Packing**

Reel ø180 mm = 3.000 Pieces/Reel  
 Reel ø330 mm = 10.000 Pieces/Reel

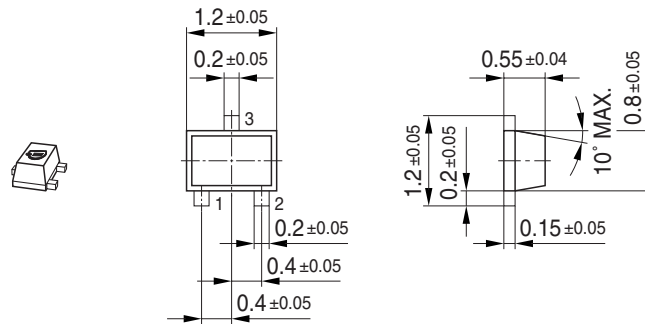




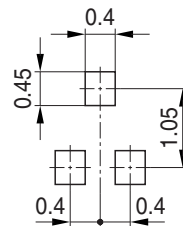
**Package TSFP-3**

**BCR196...**

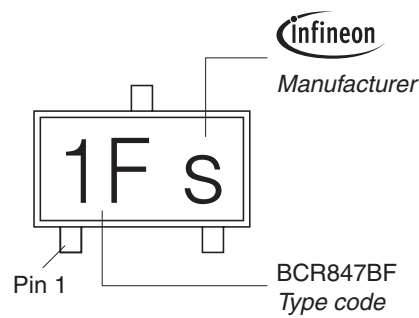
**Package Outline**



**Foot Print**

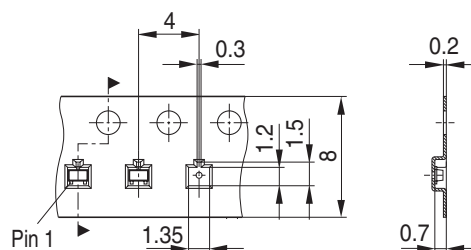


**Marking Layout (Example)**

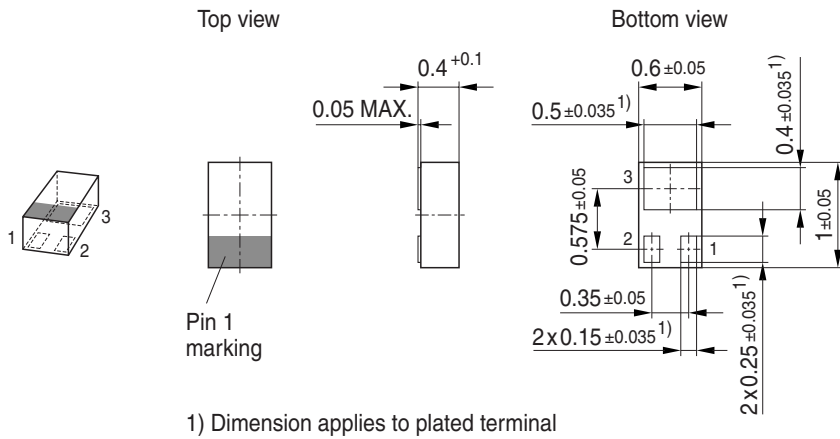


**Standard Packing**

Reel ø180 mm = 3.000 Pieces/Reel  
 Reel ø330 mm = 10.000 Pieces/Reel

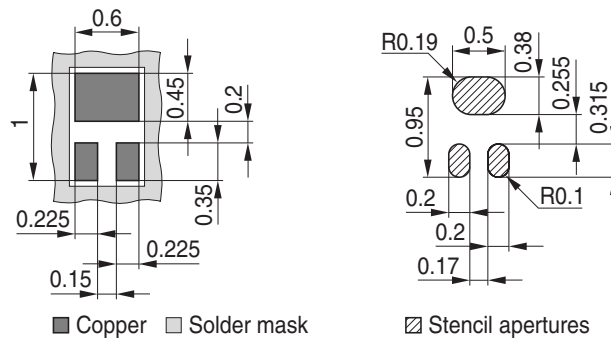


**Package Outline**

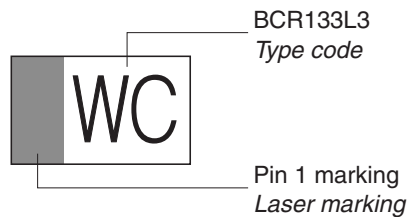


**Foot Print**

For board assembly information please refer to Infineon website "Packages"

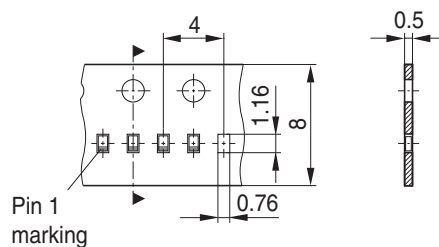


**Marking Layout**



**Standard Packing**

Reel  $\varnothing$ 180 mm = 15.000 Pieces/Reel





**BCR196...**

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